

Appl. No. 10 511 394  
Paper dated January 17, 2006  
Reply to Office action mailed September 14, 2005

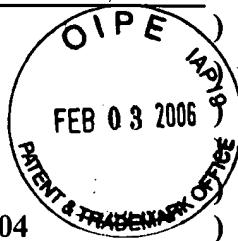
**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

AHN ET AL

SERIAL NO. 10 511 394

FILED: OCTOBER 15 2004

FOR: THERMOPLASTIC FLAME  
RETARDANT RESIN COMPOSITION



Art Unit: 1714

Examiner: SZEKELY, P. A.

DKC 1560

Commissioner for Patents  
Alexandria, VA 22313

**INFORMATION DISCLOSURE STATEMENT**

Sir:

Enclosed is a PTO Form 1449 listing references for consideration, including commonly owned Serial No. 10 512 784 (Published Application No. 2005 0228131) which is also pending in Art Unit 1714 and the references cited therein. The Examiner is respectfully requested to consider the references listed and/or enclosed herein and return an initialed copy of Form 1449 to Applicants.

A check for \$180 for the fee is attached.

Respectfully submitted,

AHN ET AL

BY

*Maria Parrish Tungol*  
Maria Parrish Tungol  
Registration No. 31,720  
Telephone: (571) 275-1111

I hereby certify that this correspondence is being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313 on January 17, 2006

By *MPT*

 <p><b>U.S. Department of Commerce</b> <b>INFORMATION DISCLOSURE CITATION</b> <b>IN AN APPLICATION</b> <i>(Use several sheets if necessary)</i></p>	<b>ATTY. DOCKET NO.</b> <b>DKC 1560</b>	<b>SERIAL NO.:</b> <b>10 511 394</b>
	<b>APPLICANT:</b> <b>AHN ET AL</b>	
	<b>FILING DATE:</b> <b>OCTOBER 15, 2004</b>	<b>GROUP:</b> <b>1714</b>

**U.S. PATENT DOCUMENTS**

EXAMINER INITIALS	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	3 383 435	05/14/68	Cizek			
	3 883 613	05/13/75	Cooper			
	3 639 506	02/01/72	Haaf			
	4 526 917	07/02/85	Axelrod			
	4 578 423	03/25/86	Deets et al.			
	4 599 380	07/08/86	Ueda et al.			

**FOREIGN PATENT DOCUMENTS**

EXAMINER INITIALS	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO
	EP 0 359 469 A2	03/21/90	Europe			X	
	EP 1 069 1587A1	1/17/01	Europe			X	
	9 - 183886	09/15/97	Japan				X
	2001-107434	12/07/01	Korea				X
	2001-55739	07/04/01	Korea				X

EXAMINER INITIALS	OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)
	Abstract of JP Laid Open Application 9-183886 published July 15, 1997 Abstract of Korea Laid Open Application 2001-107434 published December 7, 2001 Abstract of Korea Laid Open Application 2001-55739 published July 4, 2001 Abstract of German Patent Application DE 198 60 509 published March 9, 2000
EXAMINER	DATE CONSIDERED

<b>U.S. Department of Commerce</b> <b>INFORMATION DISCLOSURE CITATION</b> <b>IN AN APPLICATION</b> <i>(Use several sheets if necessary)</i>		<b>ATTY. DOCKET NO.</b>	<b>SERIAL NO.:</b>
		DKC 1560	10 511 394
		<b>APPLICANT:</b> AHN ET AL	
<b>FILING DATE:</b>	<b>GROUP:</b>		
OCTOBER 15, 2004	1714		

**U.S. PATENT DOCUMENTS**

EXAMINER INITIALS	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	6 646 032	11/11/03	Jang et al.			
	6 716 900	04/06/04	Jang et al.			1/16/02
	6 838 497	01/04/05	Hong et al.			8/29/02
	2005 0228131	10/13/05	Jang et al.			4/14/04

**FOREIGN PATENT DOCUMENTS**

EXAMINER INITIALS	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
						YES	NO
	07-048491	02/21/95	Japan				X
	09-259796	10/08/96	Japan				X
	09-137032	05/27/97	Japan				X

EXAMINER INITIALS	OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)
	Abstract of JP Laid Open Application 07-048491 published February 21, 1995 Abstract of JP Laid Open Application 09-259796 published October 8, 1996 Abstract of JP Laid Open Application 09-137032 published May 27, 1997
EXAMINER	DATE CONSIDERED